

Chapter 3 Chassis Parameters

Basic Parameters	
Chassis style	Rackmount
Chassis structure	2U
Applicable motherboard	EEB(12*13)/CEB(12*10.5)/ATX(12*9.5)/Micro ATX
Supported motherboard brands	Gooxi, Intel, ASUS, SuperMicro, TYAN, MSI, GIGABYTE and more
Power type	Single power and 1+1 redundant power
Number of supported power supplies	1
SGPIO	Support
Backplane	12Gb/s SAS data backplane
Supported hot-swap hard drives	Supportive, compatible with SAS and SATA drives
Supported hot-swap hard fans	Support
Hard driver site	Eight 3.5-inch (or 2.5-inch) hot-swap hard disk sites; one optional 3.5-inch or 2.5-inch non-hot-swap expandable site
Hard disk shockproof system	Hard disk bracket is designed with EMI spring. The unique shockproof fan design can reduce the resonance between the fan and hard disk without affecting the I/O speed of hard disks.
Cooling system	3* 8038 fans are the standard configuration
Windshield	Optional configuration
Intelligent control of temperature	Support
Expanded card site	7 half-height PCI or PCI-E expansion card slots, and 3 optional transversal full-height expansion card slots
Supported rails	Optional
Apparent Parameters	
Front panel interface	2* USB, 1 power button, 1 restart button, 1 hard disk indicator, 1 system failure light, 2 network indicators
Free screws dismantle	Support
Fixed mode of cabinet	Normal
Configuration Parameters	
Product material	Imported SGCC (galvanized steel sheet), ABS panel and punching net
Chassis dimension	670*444*87.6mm (Depth * Width * Height)
Chassis weight	10kg

Package dimension	902*591*228mm (Length * Width * Height)
Overall gross weight	12KG
Safety certification	CE, FCC, RoHS

Note: This manual is a general instruction of RMC2108-670-HS series. Specific parameters of each type please refer to the chassis detailed parameters.